

RClamp0502BA Low Capacitance RailClamp® ESD & CDE Protection

PROTECTION PRODUCTS

Description

RailClamp® TVS diodes are specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (cable discharge events), and EFT (electrical fast transients).

The RClamp®0502BA has a typical capacitance of only 0.50pF (pin1 to 2). This means it can be used on circuits operating in excess of 3GHz with minimal signal attenuation. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (\pm 18kV air, \pm 12kV contact discharge). Each device can be configured to protect 1 bidirectional line or two unidirectional lines.

These devices are in a small SC-75 (SOT-523) package and feature a lead-free, matte tin finish. They are compatible with both lead free and SnPb assembly techniques. They are designed for use in applications where board space is at a premium. The combination of small size, low capacitance, and high level of ESD protection makes them a flexible solution for applications such as HDMI, MDDI, antenna circuits, Automatic Test Equipment, USB 2.0/3.0, and Infiniband circuits.

Nominal Dimensions (mm)



Features

- Transient protection for high-speed data lines to IEC 61000-4-2 (ESD) ±18kV (air), ±12kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Surge) 5A (8/20µs)
- Protects up to two I/O lines
- Low capacitance (<1pF)
- No insetion loss to > 3.0 GHz
- Low profile (<1mm)
- Low leakage current and clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

Mechanical Characteristics

- SC-75 (SOT-523) package
- Lead Finish: Matte Tin
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel

Applications

- Mobile Display Digital Interface (MDDI)
- USB 2.0/USB 3.0
- GaAs Photodetector Protection
- HBT Power Amp Protection
- Infiniband Transceiver Protection

Schematic & Pin Configuration



Rev 4.0 6/6/2017

Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = $8/20\mu s$)	Р _{рк}	125	W
Peak Pulse Current (tp = $8/20\mu s$)	I _{PP}	5	А
ESD per IEC 61000-4-2 (Air) ⁽¹⁾ ESD per IEC 61000-4-2 (Contact) ⁽¹⁾	V _{ESD}	±18 ±12	kV
Operating Temperature	T,	-55 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V _{RWM}	Pin 1 or Pin 2 to Pin 3, and between Pin 1 & 2				5	V
Reverse Breakdown Voltage	V _{BR}	I _{BR} = 1mA, Pin 1 or Pin 2 to Pin 3		6			V
Reverse Leakage Current	I _R	V _{RWM} = 5V, Pin 1 or Pin 2 to Pin 3 and between Pin 1 & 2				1	μΑ
Clamping Voltage	V _c	t _p = 8/20μs Pin 1 or Pin 2 to Pin 3	I _{pp} = 1A			15	V
		t _p = 8/20μs Pin 1 or Pin 2 to Pin 3	$I_{pp} = 5A$			22	
		t _p = 8/20μs between Pin 1 & 2	I _{pp} = 5A			25	
Junction Capacitance C _J	C	$V_{R} = 0V, f = 1MHz$	Pin 1 to Pin 2		0.5	0.9	рF
			Pin 1 or Pin 2 to Pin 3			1.2	рF

Notes:

1) ESD gun return path connected to ESD ground plane.

Typical Characteristics

Non Repetitive Peak Pulse Power vs. Pulse Time



Clamping Voltage vs. Peak Pulse Current (tp=8/20µs)









TLP Characteristic



ESD Clamping (8kV Contact per IEC 61000-4-2)



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Typical Characteristics (Continued)



Analog Crosstalk





RClamp0502BA Final Datasheet Revision Date

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Application Information

Device Connection Options

This device is optimized for protection of 1 line operating in excess of 3GHz. It may also be used to protect two lines operating in excess of 2.0GHz. The device is connected as follows:

Protection for one line with <1pF capacitance can be achieved by connecting one data line to either pin 1 or pin 2 with the other pin connected to ground. Pin 3 is not connected. The connection to ground should be made directly to a ground plane. The path length should also be kept as short as possible to minimize parasitic inductance.

Protection of two lines is achieved by connecting data lines at pins 1 & 2. Pin 3 is connected to ground. The connection to ground should be made directly to a ground plane. The path length should also be kept as short as possible to minimize parasitic inductance.

Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Figure 1. Pin Configuration



Outline Drawing - SC75 (SOT-523)



Land Pattern - SC75 (SOT-523)



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Marking Code



YW = Date Code

Tape and Reel Specification



Ordering Information

Part Number	Qty per Reel	Reel Size
RClamp0502BATCT	3,000	7″



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